

A YANG Data Model for Microwave Topology

draft-ietf-ccamp-mw-topo-yang-07

<https://datatracker.ietf.org/doc/draft-ietf-ccamp-mw-topo-yang/>

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Status

- Last Call on v5 was completed
- Resolution of comments found in:
 - <https://github.com/ietf-ccamp-wg/draft-ietf-ccamp-mw-topo-yang/issues/31>
- Diffs from previous edition
 - <https://author-tools.ietf.org/iddiff?url1=draft-ietf-ccamp-mw-topo-yang-05&url2=draft-ietf-ccamp-mw-topo-yang-07&difftype=--html>
- Other than last call comments, one other alignment exercise was completed
 - To align with other on-going work in Topology, the following modification was made:
 - Presence containers have been added that indicate the technology (in this case microwave) for the node or link

Plan

- Last Call comments have been resolved
- Alignment with other Topology models completed
- Ready for the next step?
- Thanks!